What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.
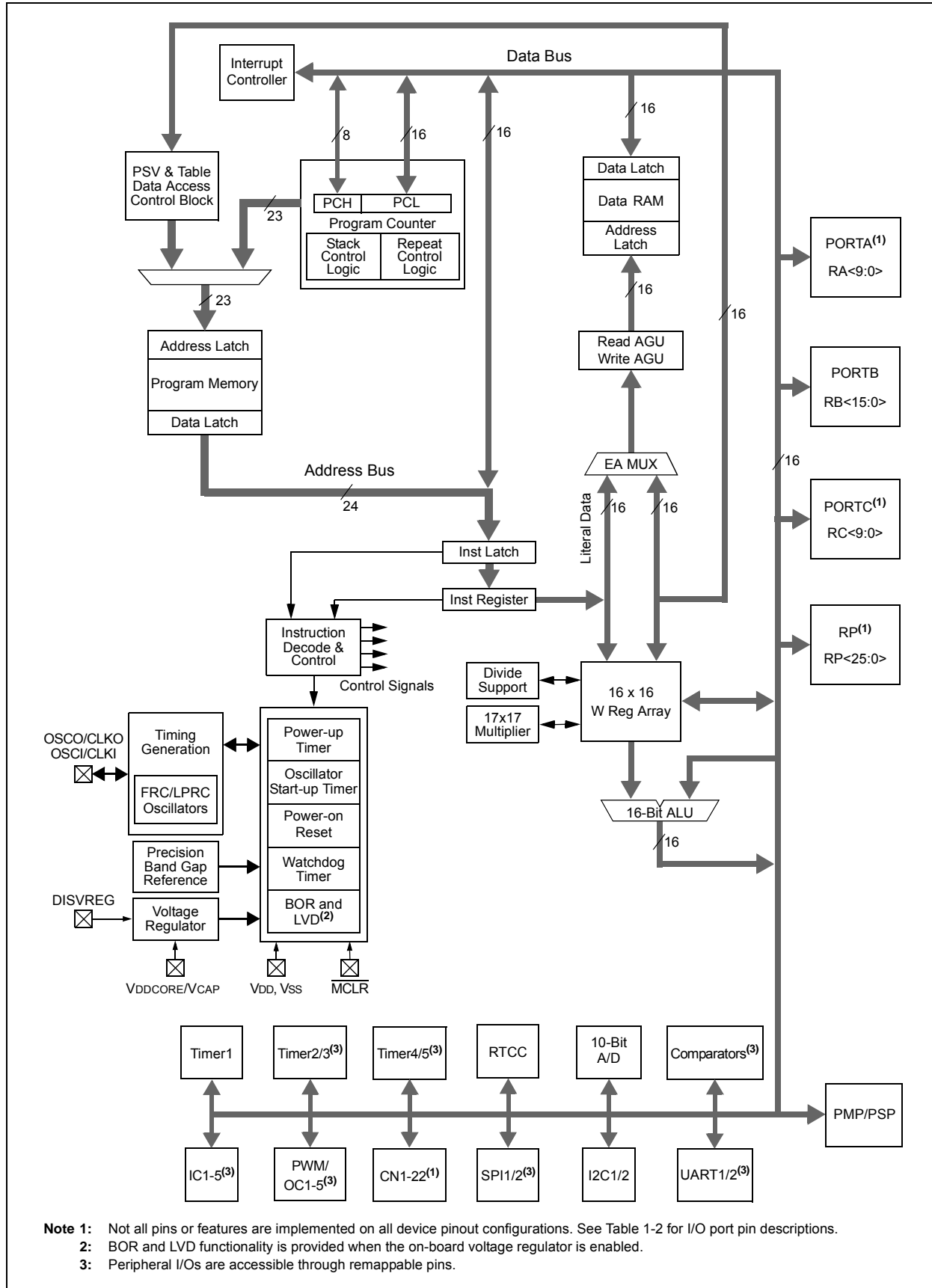
Applications of "[Embedded - Microcontrollers](#)"

Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I²C, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	35
Program Memory Size	48KB (16K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj48ga004-i-pt

FIGURE 1-1: **PIC24FJ64GA004 FAMILY GENERAL BLOCK DIAGRAM**

Note 1: Not all pins or features are implemented on all device pinout configurations. See Table 1-2 for I/O port pin descriptions.
    2: BOR and LVD functionality is provided when the on-board voltage regulator is enabled.
    3: Peripheral I/Os are accessible through remappable pins.

2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC24FJ64GA004 family of 16-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and VSS pins
  (see **Section 2.2 "Power Supply Pins"**)
- All AVDD and AVSS pins, regardless of whether or not the analog device features are used
  (see **Section 2.2 "Power Supply Pins"**)
- MCLR pin
  (see **Section 2.3 "Master Clear (MCLR) Pin"**)
- ENVREG/DISVREG and VCAP/VDDCORE pins
  (PIC24F J devices only)
  (see **Section 2.4 "Voltage Regulator Pins (ENVREG/DISVREG and VCAP/VDDCORE)"**)

These pins must also be connected if they are being used in the end application:

- PGECx/PGEDx pins used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes
  (see **Section 2.5 "ICSP Pins"**)
- OSCI and OSCO pins when an external oscillator source is used
 (see **Section 2.6 "External Oscillator Pins"**)

Additionally, the following pins may be required:

- VREF+/VREF- pins used when external voltage reference for analog modules is implemented

> **Note:** The AVDD and AVSS pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTIONS
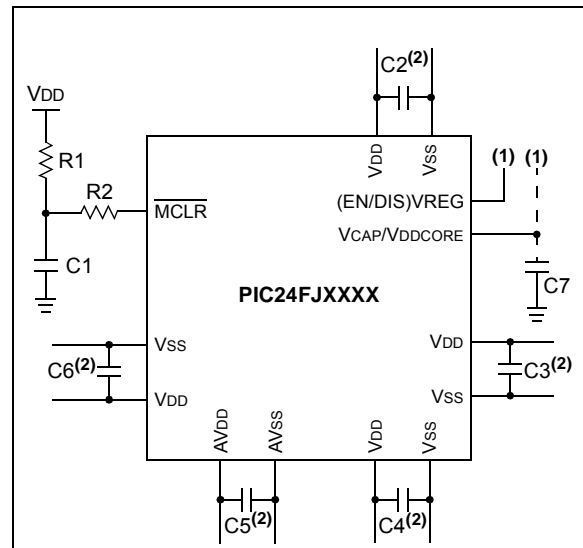
Key (all values are recommendations):

C1 through C6: 0.1 µF, 20V ceramic

C7: 10 µF, 6.3V or greater, tantalum or ceramic

R1: 10 kΩ

R2: 100Ω to 470Ω

Note 1: See **Section 2.4 "Voltage Regulator Pins (ENVREG/DISVREG and VCAP/VDDCORE)"** for an explanation of the ENVREG/DISVREG pin connections.

2: The example shown is for a PIC24F device with five VDD/VSS and AVDD/AVSS pairs. Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

2.6 External Oscillator Pins

Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to **Section 8.0 "Oscillator Configuration"** for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-5. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

In planning the application's routing and I/O assignments, ensure that adjacent port pins, and other signals in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times and other similar noise).

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- *AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro® Devices"*
- *AN849, "Basic PICmicro® Oscillator Design"*
- *AN943, "Practical PICmicro® Oscillator Analysis and Design"*
- *AN949, "Making Your Oscillator Work"*

FIGURE 2-5: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT
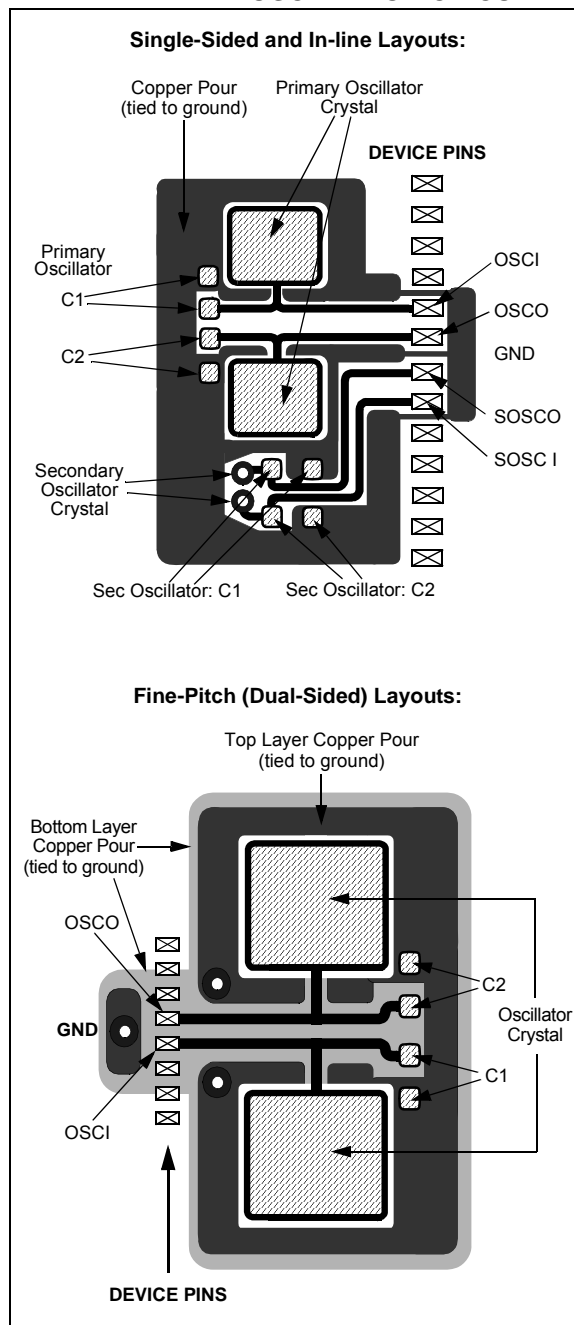
3.0 CPU

> **Note:** This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"CPU"** (DS39703).

The PIC24F CPU has a 16-bit (data) modified Harvard architecture with an enhanced instruction set and a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M instructions of user program memory space. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double-word move (MOV.D) instruction and the table instructions. Overhead-free program loop constructs are supported using the REPEAT instructions, which are interruptible at any point.

PIC24F devices have sixteen, 16-bit working registers in the programmer's model. Each of the working registers can act as a data, address or address offset register. The 16th working register (W15) operates as a Software Stack Pointer for interrupts and calls.

The upper 32 Kbytes of the data space memory map can optionally be mapped into program space at any 16K word boundary defined by the 8-bit Program Space Visibility Page Address (PSVPAG) register. The program to data space mapping feature lets any instruction access program space as if it were data space.

The Instruction Set Architecture (ISA) has been significantly enhanced beyond that of the PIC18, but maintains an acceptable level of backward compatibility. All PIC18 instructions and addressing modes are supported, either directly, or through simple macros. Many of the ISA enhancements have been driven by compiler efficiency needs.

The core supports Inherent (no operand), Relative, Literal, Memory Direct and three groups of addressing modes. All modes support Register Direct and various Register Indirect modes. Each group offers up to seven addressing modes. Instructions are associated with predefined addressing modes depending upon their functional requirements.

For most instructions, the core is capable of executing a data (or program data) memory read, a working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing trinary operations (that is, A + B = C) to be executed in a single cycle.

A high-speed, 17-bit by 17-bit multiplier has been included to significantly enhance the core arithmetic capability and throughput. The multiplier supports Signed, Unsigned and Mixed mode, 16-bit by 16-bit or 8-bit by 8-bit, integer multiplication. All multiply instructions execute in a single cycle.

The 16-bit ALU has been enhanced with integer divide assist hardware that supports an iterative non-restoring divide algorithm. It operates in conjunction with the REPEAT instruction looping mechanism and a selection of iterative divide instructions to support 32-bit (or 16-bit), divided by 16-bit, integer signed and unsigned division. All divide operations require 19 cycles to complete, but are interruptible at any cycle boundary.

The PIC24F has a vectored exception scheme with up to 8 sources of non-maskable traps and up to 118 interrupt sources. Each interrupt source can be assigned to one of seven priority levels.

A "block diagram of the CPU is shown in Figure 3-1.

3.1 Programmer's Model

The programmer's model for the PIC24F is shown in Figure 3-2. All registers in the programmer's model are memory mapped and can be manipulated directly by instructions. A description of each register is provided in Table 3-1. All registers associated with the programmer's model are memory mapped.

4.2 Data Address Space

The PIC24F core has a separate, 16-bit wide data memory space, addressable as a single linear range. The data space is accessed using two Address Generation Units (AGUs), one each for read and write operations. The data space memory map is shown in Figure 4-3.

All Effective Addresses (EAs) in the data memory space are 16 bits wide and point to bytes within the data space. This gives a data space address range of 64 Kbytes or 32K words. The lower half of the data memory space (that is, when EA<15> = 0) is used for implemented memory addresses, while the upper half (EA<15> = 1) is reserved for the Program Space Visibility (PSV) area (see **Section 4.3.3 "Reading Data From Program Memory Using Program Space Visibility"**).

PIC24FJ64GA004 family devices implement a total of 8 Kbytes of data memory. Should an EA point to a location outside of this area, an all zero word or byte will be returned.

4.2.1 DATA SPACE WIDTH

The data memory space is organized in byte-addressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all data space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

FIGURE 4-3: DATA SPACE MEMORY MAP FOR PIC24FJ64GA004 FAMILY DEVICES[1]
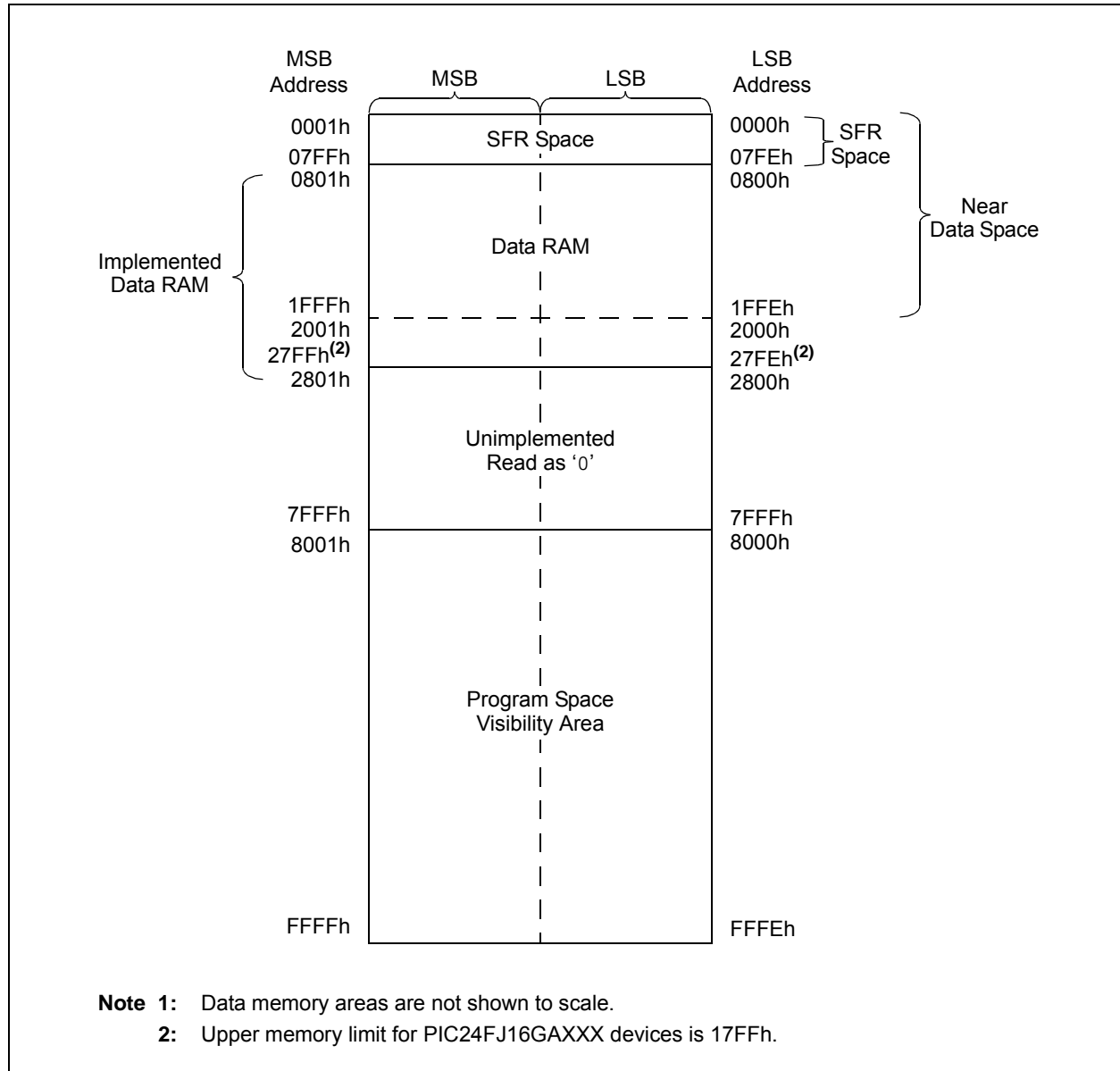

Note 1: Data memory areas are not shown to scale.

2: Upper memory limit for PIC24FJ16GAXXX devices is 17FFh.

TABLE 4-17: **PARALLEL MASTER/SLAVE PORT REGISTER MAP**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMCON	0600	PMPEN	—	PSIDL	ADRMUX1	ADRMUX0	PTBEEN	PTWREN	PTRDEN	CSF1	CSF0	ALP	—	CS1P	BEP	WRSP	RDSP	0000
PMMODE	0602	BUSY	IRQM1	IRQM0	INCM1	INCM0	MODE16	MODE1	MODE0	WAITB1	WAITB0	WAITM3	WAITM2	WAITM1	WAITM0	WAITE1	WAITE0	0000
PMADDR	0604	—	CS1	—	—	—	ADDR10	ADDR9	ADDR8	ADDR7	ADDR6	ADDR5	ADDR4	ADDR3	ADDR2	ADDR1	ADDR0	0000
PMDOUT1		Parallel Port Data Out Register 1 (Buffers 0 and 1)																0000
PMDOUT2	0606	Parallel Port Data Out Register 2 (Buffers 2 and 3)																0000
PMDIN1	0608	Parallel Port Data In Register 1 (Buffers 0 and 1)																0000
PMDIN2	060A	Parallel Port Data In Register 2 (Buffers 2 and 3)																0000
PMAEN	060C	—	PTEN14	—	—	—	PTEN10	PTEN9	PTEN8	PTEN7	PTEN6	PTEN5	PTEN4	PTEN3	PTEN2	PTEN1	PTEN0	0000
PMSTAT	060E	IBF	IBOV	—	—	IB3F	IB2F	IB1F	IB0F	OBE	OBUF	—	—	OB3E	OB2E	OB1E	OB0E	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-18: **REAL-TIME CLOCK AND CALENDAR REGISTER MAP**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ALRMVAL	0620	Alarm Value Register Window Based on ALRMPTR<1:0>																xxxx
ALCFGRPT	0622	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	0000
RTCVAL	0624	RTCC Value Register Window Based on RTCPTR<1:0>																xxxx
RCFGCAL	0626	RTCEN	—	RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	CAL7	CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-19: **DUAL COMPARATOR REGISTER MAP**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CMCON	0630	CMIDL	—	C2EVT	C1EVT	C2EN	C1EN	C2OUTEN	C1OUTEN	C2OUT	C1OUT	C2INV	C1INV	C2NEG	C2POS	C1NEG	C1POS	0000
CVRCON	0632	—	—	—	—	—	—	—	—	CVREN	CVROE	CVRR	CVRSS	CVR3	CVR2	CVR1	CVR0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-20: **CRC REGISTER MAP**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CRCCON	0640	—	—	CSIDL	VWORD4	VWORD3	VWORD2	VWORD1	VWORD0	CRCFUL	CRCMPT	—	CRCGO	PLEN3	PLEN2	PLEN1	PLEN0	0040
CRCXOR	0642	X15	X14	X13	X12	X11	X10	X9	X8	X7	X6	X5	X4	X3	X2	X1	—	0000
CRCDAT	0644	CRC Data Input Register																0000
CRCWDAT	0646	CRC Result Register																0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

PIC24FJ64GA004 FAMILY

5.2 RTSP Operation

The PIC24F Flash program memory array is organized into rows of 64 instructions or 192 bytes. RTSP allows the user to erase blocks of eight rows (512 instructions) at a time and to program one row at a time. It is also possible to program single words.

The 8-row erase blocks and single row write blocks are edge-aligned, from the beginning of program memory, on boundaries of 1536 bytes and 192 bytes, respectively.

When data is written to program memory using TBLWT instructions, the data is not written directly to memory. Instead, data written using table writes is stored in holding latches until the programming sequence is executed.

Any number of TBLWT instructions can be executed and a write will be successfully performed. However, 64 TBLWT instructions are required to write the full row of memory.

To ensure that no data is corrupted during a write, any unused addresses should be programmed with FFFFFFh. This is because the holding latches reset to an unknown state, so if the addresses are left in the Reset state, they may overwrite the locations on rows which were not rewritten.

The basic sequence for RTSP programming is to set up a Table Pointer, then do a series of TBLWT instructions to load the buffers. Programming is performed by setting the control bits in the NVMCON register.

Data can be loaded in any order and the holding registers can be written to multiple times before performing a write operation. Subsequent writes, however, will wipe out any previous writes.

> **Note:** Writing to a location multiple times without erasing it is *not* recommended.

All of the table write operations are single-word writes (2 instruction cycles), because only the buffers are written. A programming cycle is required for programming each row.

5.3 Enhanced In-Circuit Serial Programming

Enhanced In-Circuit Serial Programming uses an on-board bootloader, known as the Program Executive (PE), to manage the programming process. Using an SPI data frame format, the Program Executive can erase, program and verify program memory. For more information on Enhanced ICSP, see the device programming specification.

5.4 Control Registers

There are two SFRs used to read and write the program Flash memory: NVMCON and NVMKEY.

The NVMCON register (Register 5-1) controls which blocks are to be erased, which memory type is to be programmed and when the programming cycle starts.

NVMKEY is a write-only register that is used for write protection. To start a programming or erase sequence, the user must consecutively write 55h and AAh to the NVMKEY register. Refer to **Section 5.5 "Programming Operations"** for further details.

5.5 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. During a programming or erase operation, the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

Configuration Word values are stored in the last two locations of program memory. Performing a page erase operation on the last page of program memory clears these values and enables code protection. As a result, avoid performing page erase operations on the last page of program memory.

5.5.1 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

The user can program one row of Flash program memory at a time. To do this, it is necessary to erase the 8-row erase block containing the desired row. The general process is:

1. Read eight rows of program memory (512 instructions) and store in data RAM.
2. Update the program data in RAM with the desired new data.
3. Erase the block (see Example 5-1):
   a) Set the NVMOPx bits (NVMCON<3:0>) to '0010' to configure for block erase. Set the ERASE (NVMCON<6>) and WREN (NVMCON<14>) bits.
   b) Write the starting address of the block to be erased into the TBLPAG and W registers.
   c) Write 55h to NVMKEY.
   d) Write AAh to NVMKEY.
   e) Set the WR bit (NVMCON<15>). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.

4. Write the first 64 instructions from data RAM into the program memory buffers (see Example 5-1).
5. Write the program block to Flash memory:
   a) Set the NVMOPx bits to '0001' to configure for row programming. Clear the ERASE bit and set the WREN bit.
   b) Write 55h to NVMKEY.
   c) Write AAh to NVMKEY.
   d) Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.
6. Repeat Steps 4 and 5, using the next available 64 instructions from the block in data RAM by incrementing the value in TBLPAG, until all 512 instructions are written back to Flash memory.

For protection against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPs, as shown in Example 5-3.

EXAMPLE 5-1: ERASING A PROGRAM MEMORY BLOCK

```
; Set up NVMCON for block erase operation
      MOV     #0x4042, W0              ;
      MOV     W0, NVMCON               ; Initialize NVMCON
; Init pointer to row to be ERASED
      MOV     #tblpage(PROG_ADDR), W0  ;
      MOV     W0, TBLPAG               ; Initialize PM Page Boundary SFR
      MOV     #tbloffset(PROG_ADDR), W0 ; Initialize in-page EA[15:0] pointer
      TBLWTL  W0, [W0]                 ; Set base address of erase block
      DISI    #5                       ; Block all interrupts with priority <7
                                       ; for next 5 instructions
      MOV     #0x55, W0
      MOV     W0, NVMKEY               ; Write the 55 key
      MOV     #0xAA, W1                ;
      MOV     W1, NVMKEY               ; Write the AA key
      BSET    NVMCON, #WR              ; Start the erase sequence
      NOP                              ; Insert two NOPs after the erase
      NOP                              ; command is asserted
```

PIC24FJ64GA004 FAMILY

5.5.2 PROGRAMMING A SINGLE WORD OF FLASH PROGRAM MEMORY

If a Flash location has been erased, it can be pro-grammed using table write instructions to write an instruction word (24-bit) into the write latch. The TBLPAG register is loaded with the 8 Most Significant Bytes of the Flash address. The TBLWTL and TBLWTH instructions write the desired data into the write latches and specify the lower 16 bits of the program memory address to write to. To configure the NVMCON register for a word write, set the NVMOPx bits (NVMCON<3:0>) to '0011'. The write is performed by executing the unlock sequence and setting the WR bit (see Example 5-4).

EXAMPLE 5-4: PROGRAMMING A SINGLE WORD OF FLASH PROGRAM MEMORY

```
; Setup a pointer to data Program Memory
    MOV     #tblpage(PROG_ADDR), W0     ;
    MOV     W0, TBLPAG                  ;Initialize PM Page Boundary SFR
    MOV     #tbloffset(PROG_ADDR), W0   ;Initialize a register with program memory address

    MOV     #LOW_WORD_N, W2            ;
    MOV     #HIGH_BYTE_N, W3          ;
    TBLWTL  W2, [W0]                  ; Write PM low word into program latch
    TBLWTH  W3, [W0++]               ; Write PM high byte into program latch

; Setup NVMCON for programming one word to data Program Memory
    MOV     #0x4003, W0               ;
    MOV     W0, NVMCON               ; Set NVMOP bits to 0011

    DISI    #5                        ; Disable interrupts while the KEY sequence is written
    MOV     #0x55, W0                 ; Write the key sequence
    MOV     W0, NVMKEY
    MOV     #0xAA, W0
    MOV     W0, NVMKEY
    BSET    NVMCON, #WR               ; Start the write cycle
    NOP                               ; 2 NOPs required after setting WR
    NOP                               ;
```

6.1 Clock Source Selection at Reset

If clock switching is enabled, the system clock source at device Reset is chosen, as shown in Table 6-2. If clock switching is disabled, the system clock source is always selected according to the Oscillator Configuration bits. Refer to **Section 8.0 "Oscillator Configuration"** for further details.

TABLE 6-2: OSCILLATOR SELECTION vs. TYPE OF RESET (CLOCK SWITCHING ENABLED)

Reset Type	Clock Source Determinant
POR	FNOSC<2:0> Configuration bits (CW2<10:8>)
BOR	
$\overline{MCLR}$	COSC<2:0> Control bits (OSCCON<14:12>)
WDTO	
SWR	

6.2 Device Reset Times

The Reset times for various types of device Reset are summarized in Table 6-3. Note that the system Master Reset Signal, $\overline{SYSRST}$, is released after the POR and PWRT delay times expire.

The time that the device actually begins to execute code will also depend on the system oscillator delays, which include the Oscillator Start-up Timer (OST) and the PLL lock time. The OST and PLL lock times occur in parallel with the applicable $\overline{SYSRST}$ delay times.

The FSCM delay determines the time at which the FSCM begins to monitor the system clock source after the $\overline{SYSRST}$ signal is released.

TABLE 6-3: RESET DELAY TIMES FOR VARIOUS DEVICE RESETS

Reset Type	Clock Source	$\overline{SYSRST}$ Delay	System Clock Delay	Notes
POR[6]	EC	$T_{POR} + T_{PWRT} + T_{RST}$	—	1, 2, 7
	FRC, FRCDIV	$T_{POR} + T_{PWRT} + T_{RST}$	T_{FRC}	1, 2, 3, 7
	LPRC	$T_{POR} + T_{PWRT} + T_{RST}$	T_{LPRC}	1, 2, 3, 7
	ECPLL	$T_{POR} + T_{PWRT} + T_{RST}$	T_{LOCK}	1, 2, 4, 7
	FRCPLL	$T_{POR} + T_{PWRT} + T_{RST}$	$T_{FRC} + T_{LOCK}$	1, 2, 3, 4, 7
	XT, HS, SOSC	$T_{POR} + T_{PWRT} + T_{RST}$	T_{OST}	1, 2, 5, 7
	XTPLL, HSPLL	$T_{POR} + T_{PWRT} + T_{RST}$	$T_{OST} + T_{LOCK}$	1, 2, 4, 5, 7
BOR	EC	$T_{PWRT} + T_{RST}$	—	2, 7
	FRC, FRCDIV	$T_{PWRT} + T_{RST}$	T_{FRC}	2, 3, 7
	LPRC	$T_{PWRT} + T_{RST}$	T_{LPRC}	2, 3, 7
	ECPLL	$T_{PWRT} + T_{RST}$	T_{LOCK}	2, 4, 7
	FRCPLL	$T_{PWRT} + T_{RST}$	$T_{FRC} + T_{LOCK}$	2, 3, 4, 7
	XT, HS, SOSC	$T_{PWRT} + T_{RST}$	T_{OST}	2, 5, 7
	XTPLL, HSPLL	$T_{PWRT} + T_{RST}$	$T_{FRC} + T_{LOCK}$	2, 3, 4, 7
All Others	Any Clock	T_{RST}	—	7

Note 1: T_{POR} = Power-on Reset delay.

2: T_{PWRT} = 64 ms nominal if regulator is disabled (ENVREG tied to V$_{SS}$).

3: T_{FRC} and T_{LPRC} = RC Oscillator Start-up Times.

4: T_{LOCK} = PLL Lock Time.

5: T_{OST} = Oscillator Start-up Timer (OST). A 10-bit counter waits 1024 oscillator periods before releasing the oscillator clock to the system.

6: If Two-Speed Start-up is enabled, regardless of the primary oscillator selected, the device starts with FRC, and in such cases, FRC start-up time is valid.

7: T_{RST} = Internal State Reset Timer

REGISTER 10-3: **RPINR3: PERIPHERAL PIN SELECT INPUT REGISTER 3**

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	T3CKR4	T3CKR3	T3CKR2	T3CKR1	T3CKR0
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	T2CKR4	T2CKR3	T2CKR2	T2CKR1	T2CKR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13	**Unimplemented:** Read as '0'
bit 12-8	**T3CKR<4:0>:** Assign Timer3 External Clock (T3CK) to the Corresponding RPn Pin bits
bit 7-5	**Unimplemented:** Read as '0'
bit 4-0	**T2CKR<4:0>:** Assign Timer2 External Clock (T2CK) to the Corresponding RPn Pin bits

REGISTER 10-4: **RPINR4: PERIPHERAL PIN SELECT INPUT REGISTER 4**

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	T5CKR4	T5CKR3	T5CKR2	T5CKR1	T5CKR0
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	T4CKR4	T4CKR3	T4CKR2	T4CKR1	T4CKR0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13	**Unimplemented:** Read as '0'
bit 12-8	**T5CKR<4:0>:** Assign Timer5 External Clock (T5CK) to the Corresponding RPn Pin bits
bit 7-5	**Unimplemented:** Read as '0'
bit 4-0	**T4CKR<4:0>:** Assign Timer4 External Clock (T4CK) to the Corresponding RPn Pin bits

REGISTER 10-11: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13	**Unimplemented:** Read as '0'
bit 12-8	**SCK1R<4:0>:** Assign SPI1 Clock Input (SCK1IN) to the Corresponding RPn Pin bits
bit 7-5	**Unimplemented:** Read as '0'
bit 4-0	**SDI1R<4:0>:** Assign SPI1 Data Input (SDI1) to the Corresponding RPn Pin bits

REGISTER 10-12: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	—	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-5	**Unimplemented:** Read as '0'
bit 4-0	**SS1R<4:0>:** Assign SPI1 Slave Select Input (SS1IN) to the Corresponding RPn Pin bits

15.0 SERIAL PERIPHERAL INTERFACE (SPI)

> **Note:** This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"Serial Peripheral Interface (SPI)"** (DS39699)

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SPI module is compatible with the SPI and SIOP Motorola® interfaces.

The module supports operation in two buffer modes. In Standard mode, data is shifted through a single serial buffer. In Enhanced Buffer mode, data is shifted through an 8-level FIFO buffer.

> **Note:** Do not perform read-modify-write operations (such as bit-oriented instructions) on the SPIxBUF register in either Standard or Enhanced Buffer mode.

The module also supports a basic framed SPI protocol while operating in either Master or Slave mode. A total of four framed SPI configurations are supported.

The SPI serial interface consists of four pins:

- SDIx: Serial Data Input
- SDOx: Serial Data Output
- SCKx: Shift Clock Input or Output
- $\overline{\text{SSx}}$: Active-Low Slave Select or Frame Synchronization I/O Pulse

The SPI module can be configured to operate using 2, 3 or 4 pins. In the 3-pin mode, $\overline{\text{SSx}}$ is not used. In the 2-pin mode, both SDOx and $\overline{\text{SSx}}$ are not used.

Block diagrams of the module in Standard and Enhanced modes are shown in Figure 15-1 and Figure 15-2.

Depending on the pin count, PIC24FJ64GA004 family devices offer one or two SPI modules on a single device.

> **Note:** In this section, the SPI modules are referred to together as SPIx or separately as SPI1 and SPI2. Special Function Registers will follow a similar notation. For example, SPIxCON1 or SPIxCON2 refers to the control register for the SPI1 or SPI2 module.

To set up the SPIx module for the Standard Master mode of operation:

1. If using interrupts:
   a) Clear the SPIxIF bit in the respective IFSx register.
   b) Set the SPIxIE bit in the respective IECx register.
   c) Write the SPIxIP bits in the respective IPCx register to set the interrupt priority.
2. Write the desired settings to the SPIxCON1 and SPIxCON2 registers with the MSTEN bit (SPIxCON1<5>) = `1`.
3. Clear the SPIROV bit (SPIxSTAT<6>).
4. Enable SPIx operation by setting the SPIEN bit (SPIxSTAT<15>).
5. Write the data to be transmitted to the SPIxBUF register. Transmission (and reception) will start as soon as data is written to the SPIxBUF register.

To set up the SPIx module for the Standard Slave mode of operation:

1. Clear the SPIxBUF register.
2. If using interrupts:
   a) Clear the SPIxIF bit in the respective IFSx register.
   b) Set the SPIxIE bit in the respective IECx register.
   c) Write the SPIxIP bits in the respective IPCx register to set the interrupt priority.
3. Write the desired settings to the SPIxCON1 and SPIxCON2 registers with the MSTEN bit (SPIxCON1<5>) = `0`.
4. Clear the SMP bit (SPIxCON1<9>).
5. If the CKE bit is set, then the SSEN bit (SPIxCON1<7>) must be set to enable the $\overline{\text{SSx}}$ pin.
6. Clear the SPIROV bit (SPIxSTAT<6>).
7. Enable SPIx operation by setting the SPIEN bit (SPIxSTAT<15>).

REGISTER 17-1: UxMODE: UARTx MODE REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0[3]	R/W-0[3]
UARTEN[1]	—	USIDL	IREN[2]	RTSMD	—	UEN1	UEN0
bit 15							bit 8

R/C-0, HC	R/W-0	R/W-0, HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL
bit 7							bit 0

Legend:		
	C = Clearable bit	HC = Hardware Clearable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

bit 15   **UARTEN:** UARTx Enable bit[1]

       1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by UEN<1:0>
       0 = UARTx is disabled; all UARTx pins are controlled by PORT latches; UARTx power consumption is minimal

bit 14   **Unimplemented:** Read as '0'

bit 13   **USIDL:** UARTx Stop in Idle Mode bit

       1 = Discontinues module operation when device enters Idle mode
       0 = Continues module operation in Idle mode

bit 12   **IREN:** IrDA® Encoder and Decoder Enable bit[2]

       1 = IrDA encoder and decoder are enabled
       0 = IrDA encoder and decoder are disabled

bit 11   **RTSMD:** Mode Selection for UxRTS Pin bit

       1 = UxRTS pin in Simplex mode
       0 = UxRTS pin in Flow Control mode

bit 10   **Unimplemented:** Read as '0'

bit 9-8   **UEN<1:0>:** UARTx Enable bits[3]

       11 = UxTX, UxRX and BCLKx pins are enabled and used; UxCTS pin is controlled by PORT latches
       10 = UxTX, UxRX, UxCTS and UxRTS pins are enabled and used
       01 = UxTX, UxRX and UxRTS pins are enabled and used; UxCTS pin is controlled by PORT latches
       00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/BCLKx pins are controlled by PORT latches

bit 7   **WAKE:** Wake-up on Start Bit Detect During Sleep Mode Enable bit

       1 = UARTx will continue to sample the UxRX pin; interrupt is generated on falling edge, bit is cleared in hardware on following rising edge
       0 = No wake-up is enabled

bit 6   **LPBACK:** UARTx Loopback Mode Select bit

       1 = Enables Loopback mode
       0 = Loopback mode is disabled

bit 5   **ABAUD:** Auto-Baud Enable bit

       1 = Enables baud rate measurement on the next character – requires reception of a Sync field (55h); cleared in hardware upon completion
       0 = Baud rate measurement is disabled or completed

Note 1: If UARTEN = 1, the peripheral inputs and outputs must be configured to an available RPn pin. See **Section 10.4 "Peripheral Pin Select (PPS)"** for more information.

    2: This feature is only available for the 16x BRG mode (BRGH = 0).

    3: Bit availability depends on pin availability.

REGISTER 18-1: PMCON: PARALLEL PORT CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PMPEN	—	PSIDL	ADRMUX1[1]	ADRMUX0[1]	PTBEEN	PTWREN	PTRDEN
bit 15							bit 8

R/W-0	R/W-0	R/W-0[2]	U-0	R/W-0[2]	R/W-0	R/W-0	R/W-0
CSF1	CSF0	ALP	—	CS1P	BEP	WRSP	RDSP
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **PMPEN:** PMP Enable bit

1 = PMP is enabled
0 = PMP is disabled, no off-chip access is performed

bit 14 **Unimplemented:** Read as '0'

bit 13 **PSIDL:** PMP Stop in Idle Mode bit

1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-11 **ADRMUX<1:0>:** Address/Data Multiplexing Selection bits[1]

11 = Reserved
10 = All 16 bits of address are multiplexed on the PMD<7:0> pins
01 = Lower 8 bits of address are multiplexed on the PMD<7:0> pins, upper 3 bits are multiplexed on PMA<10:8>
00 = Address and data appear on separate pins

bit 10 **PTBEEN:** PMP Byte Enable Port Enable bit (16-Bit Master mode)

1 = PMBE port is enabled
0 = PMBE port is disabled

bit 9 **PTWREN:** PMP Write Enable Strobe Port Enable bit

1 = PMWR/PMENB port is enabled
0 = PMWR/PMENB port is disabled

bit 8 **PTRDEN:** PMP Read/Write Strobe Port Enable bit

1 = PMRD/$\overline{PMWR}$ port is enabled
0 = PMRD/$\overline{PMWR}$ port is disabled

bit 7-6 **CSF<1:0>:** Chip Select Function bits

11 = Reserved
10 = PMCS1 functions as chip set
01 = Reserved
00 = Reserved

bit 5 **ALP:** Address Latch Polarity bit[2]

1 = Active-high ($\overline{PMALL}$ and $\overline{PMALH}$)
0 = Active-low ($\overline{PMALL}$ and $\overline{PMALH}$)

bit 4 **Unimplemented:** Read as '0'

bit 3 **CS1P:** Chip Select 1 Polarity bit[2]

1 = Active-high ($\overline{PMCS1}$/PMCS1)
0 = Active-low ($\overline{PMCS1}$/PMCS1)

Note 1: PMA<10:2> bits are not available on 28-pin devices.
2: These bits have no effect when their corresponding pins are used as address lines.

21.0 10-BIT HIGH-SPEED A/D CONVERTER

> **Note:** This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"10-Bit A/D Converter"** (DS39705).

The 10-bit A/D Converter has the following key features:

- Successive Approximation (SAR) conversion
- Conversion speeds of up to 500 ksps
- Up to 13 analog input pins
- External voltage reference input pins
- Automatic Channel Scan mode
- Selectable conversion trigger source
- 16-word conversion result buffer
- Selectable Buffer Fill modes
- Four result alignment options
- Operation during CPU Sleep and Idle modes

Depending on the particular device pinout, the 10-bit A/D Converter can have up to three analog input pins, designated AN0 through AN12. In addition, there are two analog input pins for external voltage reference connections. These voltage reference inputs may be shared with other analog input pins. The actual number of analog input pins and the external voltage reference input configuration will depend on the specific device.

A block diagram of the A/D Converter is shown in Figure 21-1.

To perform an A/D conversion:

1. Configure the A/D module:
   a) Select the port pins as analog inputs (AD1PCFG<15:0>).
   b) Select the voltage reference source to match the expected range on the analog inputs (AD1CON2<15:13>).
   c) Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
   d) Select the appropriate sample/conversion sequence (AD1CON1<7:5> and AD1CON3<12:8>).
   e) Select how conversion results are presented in the buffer (AD1CON1<9:8>).
   f) Select the interrupt rate (AD1CON2<5:2>).
   g) Turn on the A/D module (AD1CON1<15>).
2. Configure the A/D interrupt (if required):
   a) Clear the AD1IF bit.
   b) Select the A/D interrupt priority.

REGISTER 24-1: CW1: FLASH CONFIGURATION WORD 1 (CONTINUED)

bit 3-0 **WDTPS<3:0>:** Watchdog Timer Postscaler Select bits

1111 = 1:32,768
1110 = 1:16,384
1101 = 1:8,192
1100 = 1:4,096
1011 = 1:2,048
1010 = 1:1,024
1001 = 1:512
1000 = 1:256
0111 = 1:128
0110 = 1:64
0101 = 1:32
0100 = 1:16
0011 = 1:8
0010 = 1:4
0001 = 1:2
0000 = 1:1

25.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers (MCU) and dsPIC® digital signal controllers (DSC) are supported with a full range of software and hardware development tools:

- Integrated Development Environment
  - MPLAB® X IDE Software
- Compilers/Assemblers/Linkers
  - MPLAB XC Compiler
  - MPASM™ Assembler
  - MPLINK™ Object Linker/
    MPLIB™ Object Librarian
  - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
  - MPLAB X SIM Software Simulator
- Emulators
  - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers/Programmers
  - MPLAB ICD 3
  - PICkit™ 3
- Device Programmers
  - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits and Starter Kits
- Third-party development tools

25.1 MPLAB X Integrated Development Environment Software

The MPLAB X IDE is a single, unified graphical user interface for Microchip and third-party software, and hardware development tool that runs on Windows®, Linux and Mac OS® X. Based on the NetBeans IDE, MPLAB X IDE is an entirely new IDE with a host of free software components and plug-ins for high-performance application development and debugging. Moving between tools and upgrading from software simulators to hardware debugging and programming tools is simple with the seamless user interface.

With complete project management, visual call graphs, a configurable watch window and a feature-rich editor that includes code completion and context menus, MPLAB X IDE is flexible and friendly enough for new users. With the ability to support multiple tools on multiple projects with simultaneous debugging, MPLAB X IDE is also suitable for the needs of experienced users.

Feature-Rich Editor:

- Color syntax highlighting
- Smart code completion makes suggestions and provides hints as you type
- Automatic code formatting based on user-defined rules
- Live parsing

User-Friendly, Customizable Interface:

- Fully customizable interface: toolbars, toolbar buttons, windows, window placement, etc.
- Call graph window

Project-Based Workspaces:

- Multiple projects
- Multiple tools
- Multiple configurations
- Simultaneous debugging sessions

File History and Bug Tracking:

- Local file history feature
- Built-in support for Bugzilla issue tracker

TABLE 26-2: INSTRUCTION SET OVERVIEW

Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles	Status Flags Affected
ADD	ADD	f	f = f + WREG	1	1	C, DC, N, OV, Z
	ADD	f,WREG	WREG = f + WREG	1	1	C, DC, N, OV, Z
	ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C, DC, N, OV, Z
	ADD	Wb,Ws,Wd	Wd = Wb + Ws	1	1	C, DC, N, OV, Z
	ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C, DC, N, OV, Z
ADDC	ADDC	f	f = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,Ws,Wd	Wd = Wb + Ws + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,#lit5,Wd	Wd = Wb + lit5 + (C)	1	1	C, DC, N, OV, Z
AND	AND	f	f = f .AND. WREG	1	1	N, Z
	AND	f,WREG	WREG = f .AND. WREG	1	1	N, Z
	AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N, Z
	AND	Wb,Ws,Wd	Wd = Wb .AND. Ws	1	1	N, Z
	AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N, Z
ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C, N, OV, Z
	ASR	Wb,Wns,Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N, Z
	ASR	Wb,#lit4,Wnd	Wnd = Arithmetic Right Shift Wb by lit4	1	1	N, Z
BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
	BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
BRA	BRA	C,Expr	Branch if Carry	1	1 (2)	None
	BRA	GE,Expr	Branch if Greater than or Equal	1	1 (2)	None
	BRA	GEU,Expr	Branch if Unsigned Greater than or Equal	1	1 (2)	None
	BRA	GT,Expr	Branch if Greater than	1	1 (2)	None
	BRA	GTU,Expr	Branch if Unsigned Greater than	1	1 (2)	None
	BRA	LE,Expr	Branch if Less than or Equal	1	1 (2)	None
	BRA	LEU,Expr	Branch if Unsigned Less than or Equal	1	1 (2)	None
	BRA	LT,Expr	Branch if Less than	1	1 (2)	None
	BRA	LTU,Expr	Branch if Unsigned Less than	1	1 (2)	None
	BRA	N,Expr	Branch if Negative	1	1 (2)	None
	BRA	NC,Expr	Branch if Not Carry	1	1 (2)	None
	BRA	NN,Expr	Branch if Not Negative	1	1 (2)	None
	BRA	NOV,Expr	Branch if Not Overflow	1	1 (2)	None
	BRA	NZ,Expr	Branch if Not Zero	1	1 (2)	None
	BRA	OV,Expr	Branch if Overflow	1	1 (2)	None
	BRA	Expr	Branch Unconditionally	1	2	None
	BRA	Z,Expr	Branch if Zero	1	1 (2)	None
	BRA	Wn	Computed Branch	1	2	None
BSET	BSET	f,#bit4	Bit Set f	1	1	None
	BSET	Ws,#bit4	Bit Set Ws	1	1	None
BSW	BSW.C	Ws,Wb	Write C bit to Ws<Wb>	1	1	None
	BSW.Z	Ws,Wb	Write Z bit to Ws<Wb>	1	1	None
BTG	BTG	f,#bit4	Bit Toggle f	1	1	None
	BTG	Ws,#bit4	Bit Toggle Ws	1	1	None
BTSC	BTSC	f,#bit4	Bit Test f, Skip if Clear	1	1 (2 or 3)	None
	BTSC	Ws,#bit4	Bit Test Ws, Skip if Clear	1	1 (2 or 3)	None

TABLE 27-4: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended		
Parameter No.	Typical[1]	Max	Units	Conditions	
Operating Current (IDD): PMD Bits are Set[2]					
DC20	0.650	0.850	mA	-40°C	2.0V[3]
DC20a	0.650	0.850	mA	+25°C	
DC20b	0.650	0.850	mA	+85°C	
DC20c	0.650	0.850	mA	+125°C	
DC20d	1.2	1.6	mA	-40°C	3.3V[4]
DC20e	1.2	1.6	mA	+25°C	
DC20f	1.2	1.6	mA	+85°C	
DC20g	1.2	1.6	mA	+125°C	1 MIPS
DC23	2.6	3.4	mA	-40°C	2.0V[3]
DC23a	2.6	3.4	mA	+25°C	
DC23b	2.6	3.4	mA	+85°C	
DC23c	2.6	3.4	mA	+125°C	
DC23d	4.1	5.4	mA	-40°C	3.3V[4]
DC23e	4.1	5.4	mA	+25°C	
DC23f	4.1	5.4	mA	+85°C	
DC23g	4.1	5.4	mA	+125°C	4 MIPS
DC24	13.5	17.6	mA	-40°C	2.5V[3]
DC24a	13.5	17.6	mA	+25°C	
DC24b	13.5	17.6	mA	+85°C	
DC24c	13.5	17.6	mA	+125°C	
DC24d	15	20	mA	-40°C	3.3V[4]
DC24e	15	20	mA	+25°C	
DC24f	15	20	mA	+85°C	
DC24g	15	20	mA	+125°C	16 MIPS
DC31	13	17	μA	-40°C	2.0V[3]
DC31a	13	17	μA	+25°C	
DC31b	20	26	μA	+85°C	
DC31c	40	50	μA	+125°C	
DC31d	54	70	μA	-40°C	3.3V[4]
DC31e	54	70	μA	+25°C	
DC31f	95	124	μA	+85°C	
DC31g	120	260	μA	+125°C	LPRC (31 kHz)

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

    2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDD measurements are as follows: OSCI driven with external square wave from rail-to-rail. All I/O pins are configured as inputs and pulled to VDD.
MCLR = VDD; WDT and FSCM are disabled. CPU, SRAM, program memory and data memory are operational. No peripheral modules are operating and all of the Peripheral Module Disable (PMD) bits are set.

    3: On-chip voltage regulator is disabled (DISVREG tied to VDD).

    4: On-chip voltage regulator is enabled (DISVREG tied to VSS). Low-Voltage Detect (LVD) and Brown-out Detect (BOD) are enabled.